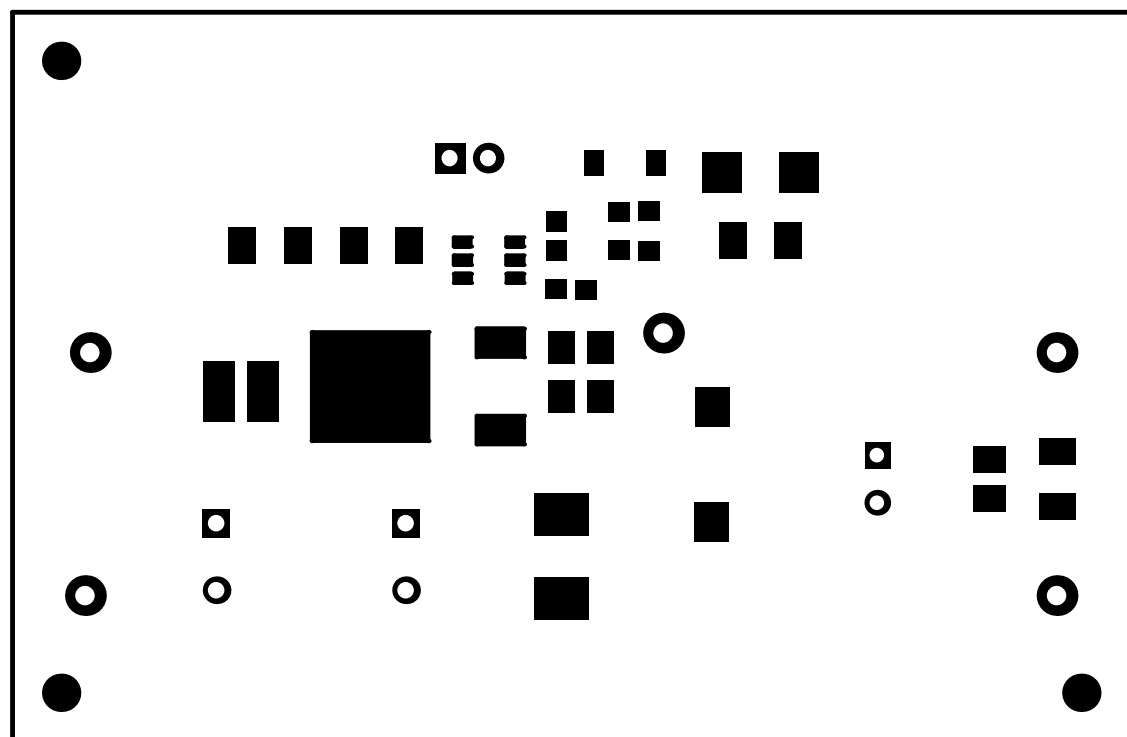
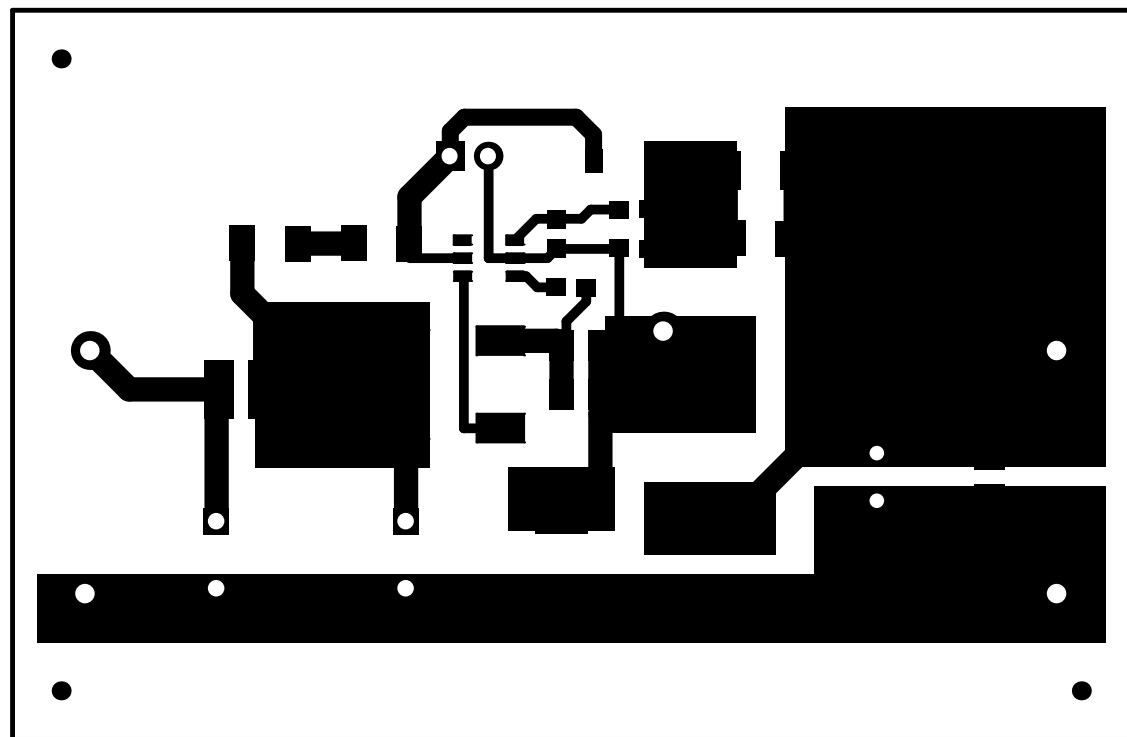


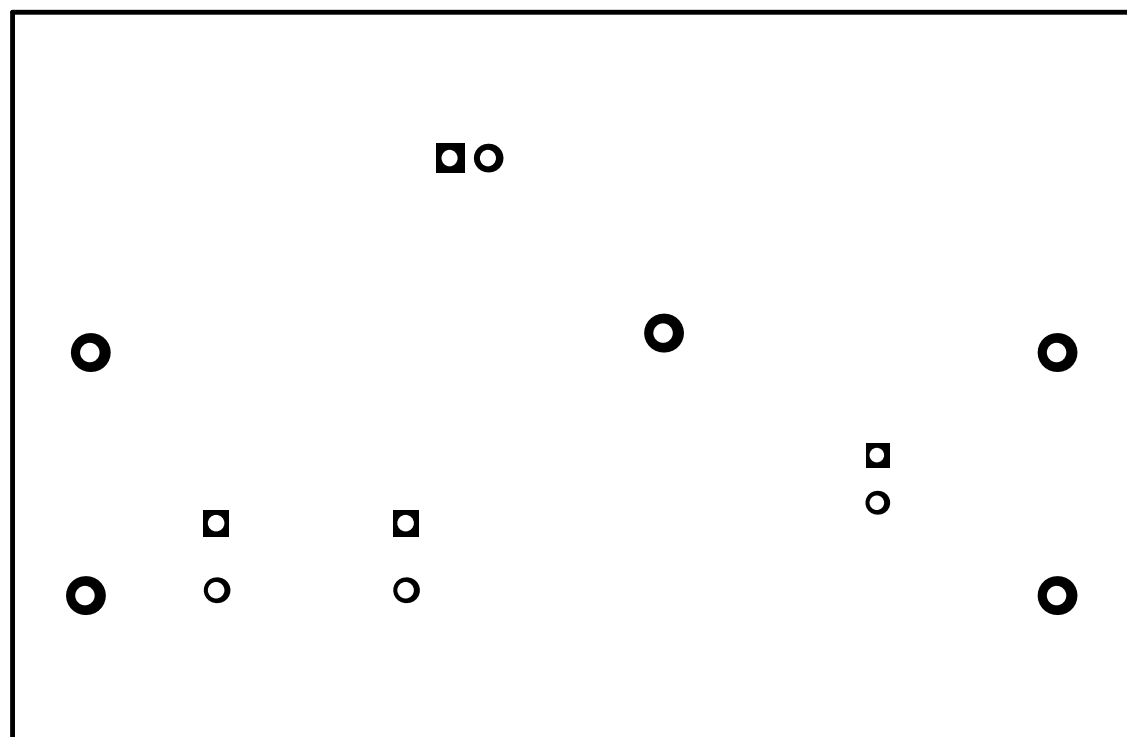
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10739	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP10739		
PLOT NAME = Top Overlay	GENERATED : 8/20/2015	5:19:05 PM	TEXAS INSTRUMENTS



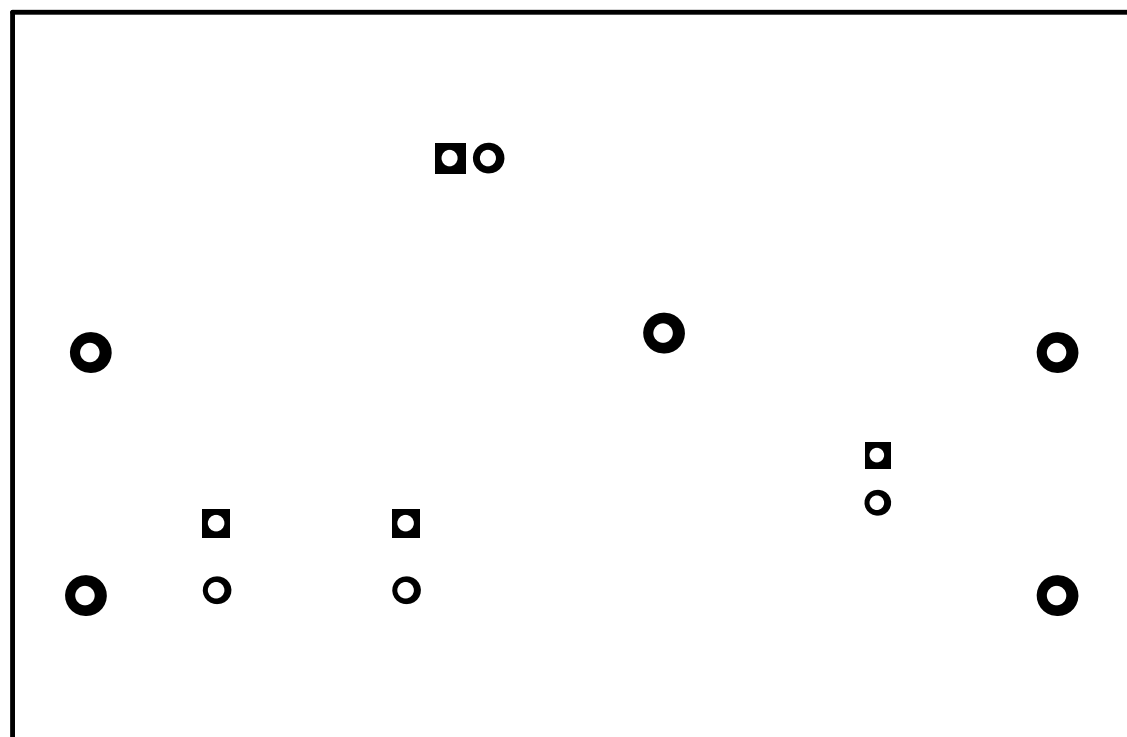
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10739	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP10739		
PLOT NAME = Top Solder Mask	GENERATED : 8/20/2015 5:19:06 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10739	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP10739		
PLOT NAME = Top Layer	GENERATED : 8/20/2015 5:19:07 PM		TEXAS INSTRUMENTS



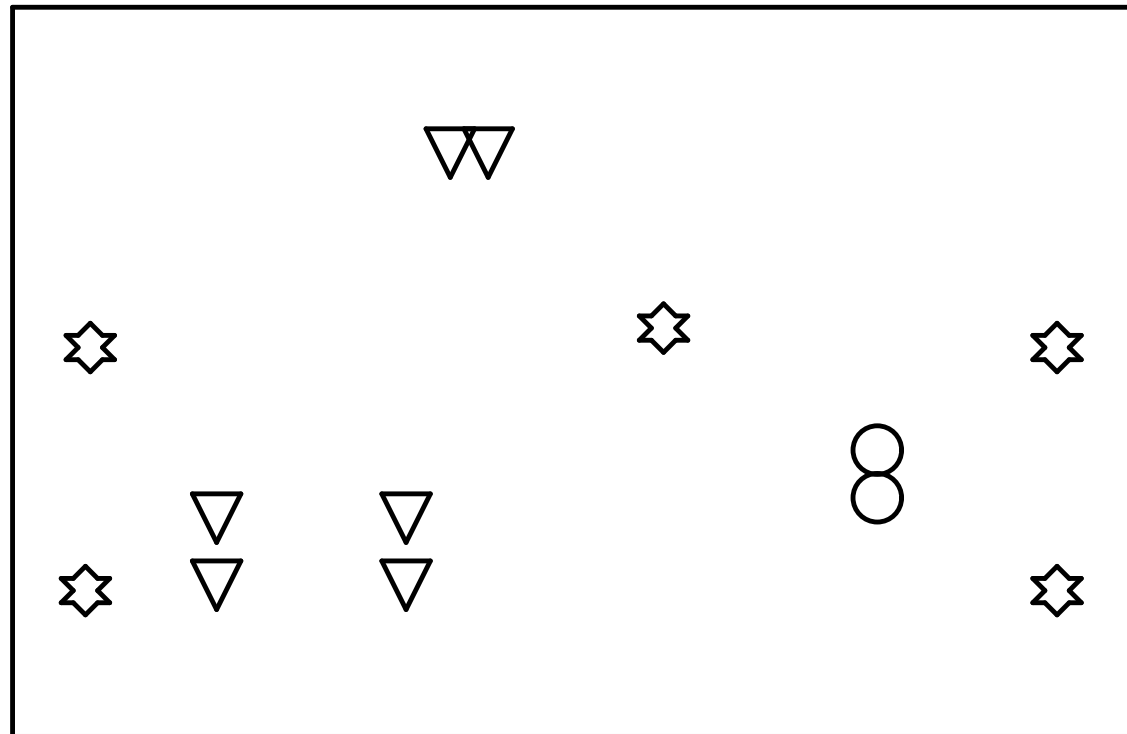
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10739	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP10739		
PLOT NAME = Bottom Layer	GENERATED : 8/20/2015 5:19:08 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10739	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP10739		
PLOT NAME = Bottom Solder Mask	GENERATED : 8/20/2015 5:19:09 PM	TEXAS INSTRUMENTS	

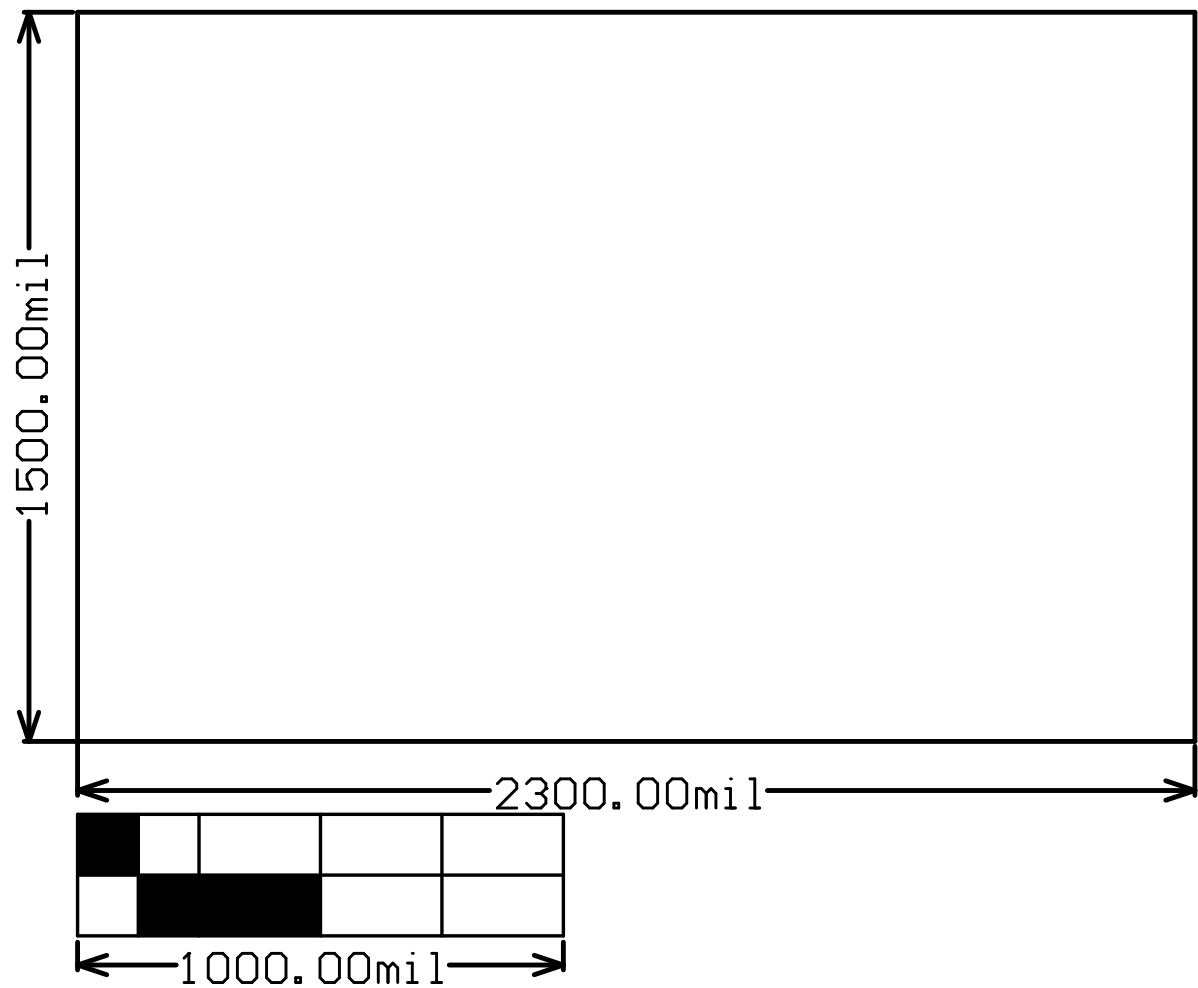


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10739	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: PMP10739		
PLOT NAME = Bottom Overlay	GENERATED : 8/20/2015 5:19:09 PM		TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	2	29.53mil (0.750mm)	PTH	Round
▽	6	33.46mil (0.850mm)	PTH	Round
☆	5	40.00mil (1.016mm)	PTH	Round
	13 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10739	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP10739		
PLOT NAME = Drill Drawing	GENERATED : 8/20/2015 5:19:10 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10739	REV: A	SVN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP10739		
PLOT NAME = Board Dimensions	GENERATED : 8/20/2015 5:19:11 PM	TEXAS INSTRUMENTS	

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